Power LDMOS transistor

Rev. 1 — 26 March 2020

1. Product profile

1.1 General description

250 W LDMOS-based power transistor suitable for use in a variety of commercial and consumer cooking, industrial, scientific and medical applications at frequencies from 2400 MHz to 2500 MHz.

The BLP2425M10S250P is designed for high-power CW applications and is assembled in a high performance plastic package.

Table 1.Typical performance

RF performance at V_{DS} = 32 V; I_{Dg} = 100 mA; T_{case} = 25 °C in a class-AB application circuit.

Test signal	f	V _{DS}	P _{L(AV)}	G _p	ησ
	(MHz)	(V)	(W)	(dB)	(%)
CW	2450	32	250	15	66.5
CW pulsed [1]	2450	32	250	15	67.5

[1] $t_p = 100 \ \mu s; \delta = 10 \ \%$

1.2 Features and benefits

- High efficiency
- Excellent ruggedness
- Integrated ESD protection
- Designed for broadband operation (2400 MHz to 2500 MHz)
- Internally input and output matched
- Thermally enhanced low cost plastic package
- For RoHS compliance see the product details on the Ampleon website

1.3 Applications

 RF power amplifiers for CW applications in the 2400 MHz to 2500 MHz frequency range such as commercial and consumer cooking, industrial, scientific and medical applications

2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
1	gate1		
2	gate2	4 3	4
3	drain2		
4	drain1		5
5	source		2

[1] Connected to flange.

3. Ordering information

Table 3.Ordering information

Type number	Package				
	Name	Description	Version		
BLP2425M10S250P		overmolded plastic earless flanged package; 4 leads	OMP-780-4F-1		

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage		-	65	V
V _{GS}	gate-source voltage		-6	+13	V
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[1]	-	225	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j\text{-}case)}$	thermal resistance from junction to case	$T_{case} = 80 \ ^{\circ}C; \ P_L = 250 \ W$	0.32	K/W

6. Characteristics

Table 6. DC characteristics

 $T_i = 25 \ ^{\circ}C$, per section; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Cymbol		Conditions		קני	IWIGA	Onit
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0 V; I _D =1.52 mA	65.00	-	-	V
V _{GS(th)}	gate-source threshold voltage	$V_{DS} = 32 \text{ V}; \text{ I}_{D} = 50 \text{ mA}$	1.33	1.82	2.33	V
I _{DSS}	drain leakage current	$V_{GS} = 0 V; V_{DS} = 32 V$	-	-	2.8	μA
I _{DSX}	drain cut-off current	$\label{eq:VGS} \begin{array}{l} V_{GS} = V_{GS(th)} + 3.75 \ V; \\ V_{DS} = 10 \ V \end{array}$	-	28.4	-	A
I _{GSS}	gate leakage current	$V_{GS} = 11 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	280	nA
g _{fs}	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 7.6 \text{ A}$	-	10.1	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ I _D = 5.32 A	-	95	-	mΩ

Table 7. RF characteristics

Test signal: pulsed at 2450 MHz; RF performance at $V_{DS} = 32$ V; $I_{Dq} = 100$ mA; $t_p = 100 \ \mu$ s; $\delta = 10 \%$; $T_{case} = 25 \ ^{\circ}C$; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	P _L = 250 W	13	15	-	dB
RL _{in}	input return loss	P _L = 250 W	-	–15	-	dB
η _D	drain efficiency	P _L = 250 W	61	64	-	%

7. Test information

7.1 Ruggedness in class-AB operation

The BLP2425M10S250P is capable of withstanding a load mismatch corresponding to VSWR = 20 : 1 through all phases with a time rate of 55 ms/degree under the following conditions: V_{DS} = 32 V; I_{Dq} = 100 mA; P_L = 260 W (CW); f = 2450 MHz; T_{case} = 25 °C.

7.2 Impedance information

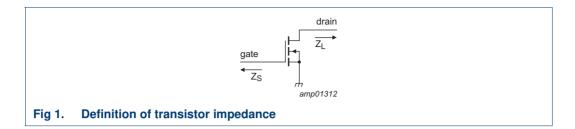
Table 8. Typical impedance

Measured load-pull data; measured on a single section of the push-pull transistor; $I_{Dq} = 50 \text{ mA}$; $V_{DS} = 32 \text{ V}$.

f	Z _S [1]	Z _L [1]
(MHz)	(Ω)	(Ω)
2400	12.1 – 1.9j	4.1 – 5.7j
2450	8.2 – 0.5j	3.7 – 5.5j
2500	5.4 – 1.0j	3.3 – 5.4j

[1] Z_S and Z_L defined in Figure 1.

Power LDMOS transistor



7.3 Test circuit

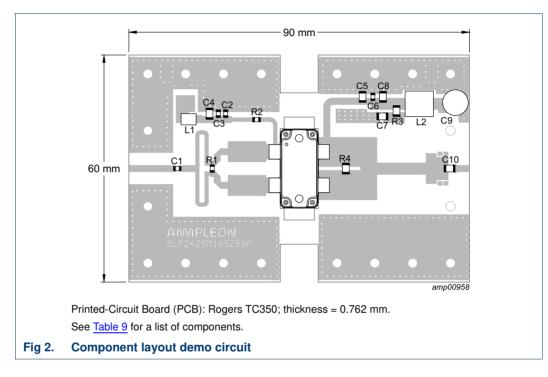
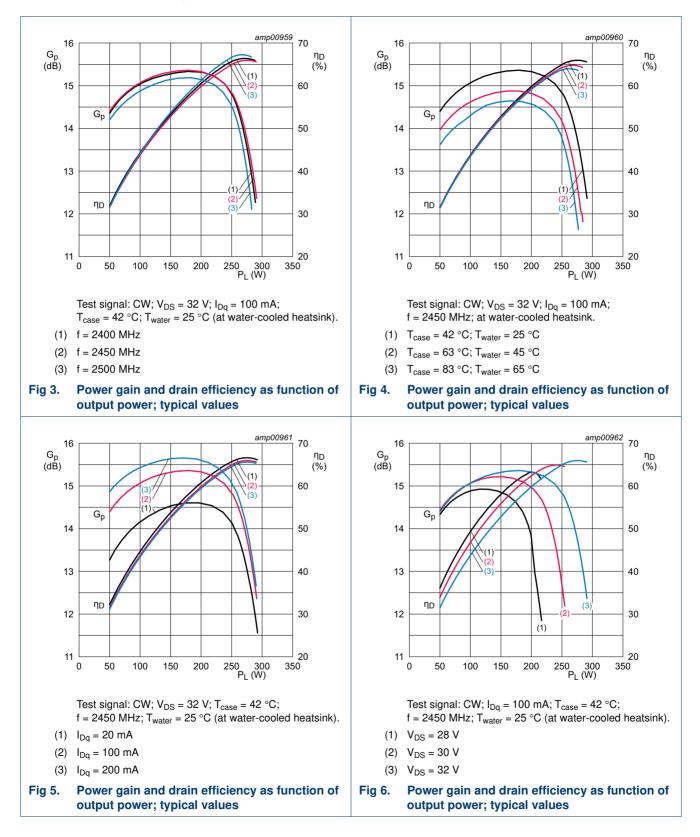


Table 9. List of components

See Figure 2 for component layout.

Component	Description	Value	Remarks
C1, C2	multilayer ceramic chip capacitor	22 pF	ATC 800A
C3, C6	multilayer ceramic chip capacitor	1000 pF, 50 V	C0805
C4, C8	multilayer ceramic chip capacitor	1 μF, 50 V	C1206
C5, C10	multilayer ceramic chip capacitor	22 pF	ATC 800B
C7	multilayer ceramic chip capacitor	560 pF	ATC 100B
C9	electrolytic capacitor	100 μF, 63 V	
L1	ferrite bead inductor	47 Ω, 100 MHz	Fair-Rite: 2743019447
L2	inductor	0.05 μΗ	Coilcraft: SLC7530D-500MLC
R1	chip resistor	100 Ω	R0805
R2	chip resistor	10 Ω	R0805
R3	chip resistor	1.5 Ω	R1206
R4	chip resistor	10 Ω	R1206

Power LDMOS transistor



7.4 Graphical data

Power LDMOS transistor

8. Package outline

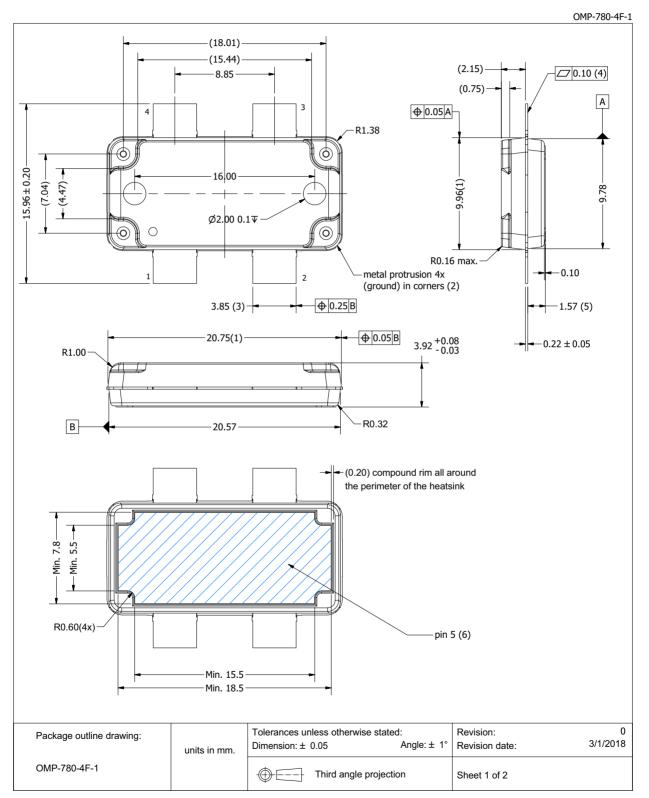


Fig 7. Package outline OMP-780-4F-1 (sheet 1 of 2)

BLP2425M10S250P

All information provided in this document is subject to legal disclaimers.

Power LDMOS transistor

			Drawing Notes				
Items			Description				
	Dimensions are exc	cluding mold protru	rusion. All areas located adjacent to the leads have a maximum mold protrusion of 0.2				
(1)	mm (per side) and i	max. 0.62 mm in le	length.				
	At all other areas th	At all other areas the mold protrusion is maximum 0.15 mm per side. See also detail B.					
(2)	The metal protrusio	The metal protrusion (tie bars) in the corner will not stick out of the molding compound protrusions (detail A).					
(3)	The lead dambar (n	netal) protrusions	are not included. Add 0.14 mm max to the total lead dimension at the dambar location				
(4)	The lead coplanarit	y over all leads is	0.1 mm maximum.				
(5)	Dimension is meas	ured 0.5 mm from	n the edge of the top package body.				
(6)	The hatched area in	ndicates the expos	sed metal heatsink.				
(7)	The leads and expo	sed heatsink are	plated with matte Tin (Sn).				
		MAK/					
	B	lead	A ad dambar location DETAIL A SCALE 25:1 0,15 max.(1) 0,25 max.(1) 0,25 max.(1) 0,25 max.(1) 0,25 max.(1) 0,25 max.(1)				
ackage o	utline drawing:	lead	scale 25:1				

Fig 8. Package outline OMP-780-4F-1 (sheet 2 of 2)

BLP2425M10S250P

All information provided in this document is subject to legal disclaimers.

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 10.ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C1 🛄
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	1C 🛛

[1] CDM classification C1 is granted to any part that passes after exposure to an ESD pulse of 250 V.

[2] HBM classification 1C is granted to any part that passes after exposure to an ESD pulse of 1000 V.

10. Abbreviations

Table 11. Abbreviations			
Acronym	Description		
CW	Continuous Wave		
ESD	ElectroStatic Discharge		
LDMOS	Laterally Diffused Metal-Oxide Semiconductor		
MTF	Median Time to Failure		
RoHS	Restriction of Hazardous Substances		
VSWR	Voltage Standing Wave Ratio		

11. Revision history

Table 12.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLP2425M10S250P v.1	20200326	Product data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.ampleon.com.

12.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Ampleon does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Ampleon sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Ampleon and its customer, unless Ampleon and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Ampleon product is deemed to offer functions and qualities beyond those described in the Product data sheet.

12.3 Disclaimers

Maturity — The information in this document can only be regarded as final once the relevant product(s) has passed the Release Gate in Ampleon's release process. Prior to such release this document should be regarded as a draft version.

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Ampleon does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Ampleon takes no responsibility for the content in this document if provided by an information source outside of Ampleon.

In no event shall Ampleon be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Ampleon's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Ampleon.

Right to make changes — Ampleon reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Ampleon products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Ampleon product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Ampleon and its suppliers accept no liability for inclusion and/or use of Ampleon products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Ampleon makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Ampleon products, and Ampleon accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Ampleon product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Ampleon does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Ampleon products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Ampleon does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Ampleon products are sold subject to the general terms and conditions of commercial sale, as published at http://www.ampleon.com/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Ampleon hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Ampleon products by customer.

Power LDMOS transistor

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific Ampleon product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Ampleon accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Ampleon's warranty of the product for such

automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Ampleon's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Ampleon for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Ampleon's standard warranty and Ampleon's product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

12.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

13. Contact information

For more information, please visit: <u>http://www.ampleon.com</u> For sales office addresses, please visit: <u>http://www.ampleon.com/sales</u>

14. Contents

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
2	Pinning information 2
3	Ordering information 2
4	Limiting values 2
5	Thermal characteristics 2
6	Characteristics 3
7	Test information 3
7.1	Ruggedness in class-AB operation
7.2	Impedance information
7.3	Test circuit 4
7.4	Graphical data 5
8	Package outline 6
9	Handling information 8
10	Abbreviations 8
11	Revision history 8
12	Legal information 9
12.1	Data sheet status 9
12.2	Definitions9
12.3	Disclaimers
12.4	Trademarks 10
13	Contact information 10
14	Contents 11

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© Ampleon Netherlands B.V. 2020.

All rights reserved.

For more information, please visit: http://www.ampleon.com For sales office addresses, please visit: http://www.ampleon.com/sales

Date of release: 26 March 2020 Document identifier: BLP2425M10S250P